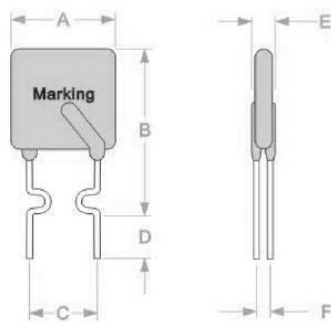
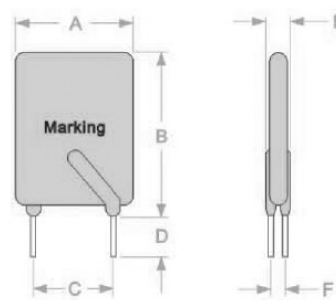


Product Dimensions(mm)

Part Number	A	B	C	D	E	F	Lead	
	Max.	Max.	Typ.	Min.	Max.	Typ.	Style	Size(φ)
LP30-090	6.0	13.8	5.1	7.6	3.0	0.9	1	0.6
LP30-110	7.8	14.0	5.1	7.6	3.0	0.9	1	0.6
LP30-135	8.9	14.0	5.1	7.6	3.0	0.9	1	0.6
LP30-160	9.7	17.0	5.1	7.6	3.0	0.9	1	0.6
LP30-185	10.7	17.0	5.1	7.6	3.0	0.9	1	0.6
LP30-250	11.7	19.0	5.1	7.6	3.0	0.9	1	0.6
LP30-300	11.7	21.0	5.1	7.6	3.0	1.2	2	0.8
LP30-400	14.2	23.0	5.1	7.6	3.0	1.2	2	0.8
LP30-500	14.4	28.0	10.2	7.6	3.0	1.2	2	0.8
LP30-600	16.7	28.0	10.2	7.6	3.0	1.2	2	0.8
LP30-700	19.4	29.6	10.2	7.6	3.0	1.2	2	0.8
LP30-800	21.6	31.9	10.2	7.6	3.0	1.2	2	0.8
LP30-900	24.5	36.4	10.2	7.6	3.0	1.2	2	0.8



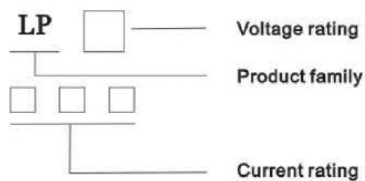
Style1



Style2

※Lead materials: Tin-plate metal wire.
 ※Lead-free devices are available.

Part Marking System



ESKA Fuses

■Electrical Characteristics

Part Number	I_H (A)	I_T (A)	T_{trip} (S)	V_{max} (V)	I_{max} (A)	Pd_{typ} (W)	R_{min} (Ω)	R_{max} (Ω)
LP30-090	0.90	1.80	7.1	30	40	0.91	0.07	0.12
LP30-110	1.10	2.20	6.6	30	40	1.00	0.05	0.10
LP30-135	1.35	2.70	7.3	30	40	1.11	0.04	0.08
LP30-160	1.60	3.20	8.0	30	40	1.20	0.03	0.07
LP30-185	1.85	3.70	8.7	30	40	1.27	0.03	0.06
LP30-250	2.50	5.00	10.3	30	40	1.34	0.02	0.04
LP30-300	3.00	6.00	10.8	30	40	2.00	0.02	0.05
LP30-400	4.00	8.00	12.7	30	40	2.50	0.01	0.03
LP30-500	5.00	10.00	14.5	30	40	3.00	0.01	0.03
LP30-600	6.00	12.00	16.0	30	40	3.50	0.005	0.02
LP30-700	7.00	14.00	17.5	30	40	3.80	0.005	0.02
LP30-800	8.00	16.00	18.8	30	40	4.00	0.005	0.02
LP30-900	9.00	18.00	20.0*	30	40	4.20	0.005	0.01

● I_H =Hold current:maximum current at which the device will not trip at 25°C still air.

● I_T =Trip current:minimum current at which the device will always trip at 25°C still air.

● T_{trip} =Maximum time to trip(s) at 5* I_H .

● V_{max} =Maximum voltage device can withstand without damage at rated current.

● I_{max} =Maximum fault current device can withstand without damage at rated voltage.

● Pd_{typ} =Typical power dissipation:typical amount of power dissipated by the device when in state air environment.

● R_{min} =Minimum device resistance at 25°C prior to tripping.

● R_{max} =Maximum device resistance at 25°C prior to tripping.

* Device tested at 40A.

■Thermal Derating Chart- I_H (A)

Part Number	Maximum ambient operating temperatures(°C)								
	-40	-20	0	25	40	50	60	70	85
LP30-090	1.40	1.25	1.10	0.90	0.75	0.69	0.65	0.60	0.50
LP30-110	1.75	1.52	1.33	1.10	0.99	0.90	0.80	0.73	0.63
LP30-135	2.15	1.94	1.70	1.35	1.20	1.14	1.00	0.90	0.81
LP30-160	2.49	2.21	1.94	1.60	1.42	1.31	1.19	1.03	0.88
LP30-185	2.87	2.59	2.28	1.85	1.63	1.52	1.33	1.21	1.05
LP30-250	3.82	3.44	3.03	2.50	2.17	2.00	1.81	1.59	1.39
LP30-300	4.55	4.10	3.60	3.00	2.65	2.51	2.24	2.01	1.74
LP30-400	6.00	5.40	4.74	4.00	3.47	3.28	2.82	2.63	2.26
LP30-500	7.44	6.68	5.80	5.00	4.30	4.03	3.58	3.22	2.77
LP30-600	8.90	7.99	7.08	6.00	5.13	4.82	4.27	3.84	3.30
LP30-700	10.35	9.30	8.21	7.00	5.95	5.58	4.96	4.46	3.84
LP30-800	11.60	10.60	9.35	8.00	6.79	6.36	5.64	5.07	4.36
LP30-900	13.25	11.90	10.49	9.00	7.53	7.12	6.32	5.69	4.88